## **MOLEX**<sup>®</sup> PRODUCT SPECIFICATION

### 1.27mm PITCH SLIM-GRID<sup>®</sup> VERTICAL SMT RECEPTACLES (BOARD TO BOARD)

#### 1.0 SCOPE

This Product Specification covers the <u>1.27</u>mm centerline (pitch) printed circuit board (PCB) connector series

#### 2.0 PRODUCT DESCRIPTION

#### 2.1 PRODUCT NAME AND SERIES NUMBER(S)

Product Name	Series Number
1.27 mm Pitch SLIM-GRID <sup>®</sup> Vertical SMT Receptacle	78120



This connector mates with Molex Header Series: 87933, 200989, 201021, 201022, 201173

#### 2.2 DIMENSIONS, MATERIALS, PLATINGS AND MARKINGS

See Sales Drawing 781200001 (PSD) for information on dimensions, materials, plating and markings.

#### 2.3 SAFETY AGENCY APPROVALS

UL File Number: File E29179, Vol 10 CSA File Number: 152514 (LR 19980)

REVISION:	ECR/ECN INFORMATION:	TITLE: PRODU	CT SPECIFICATIO	ON	SHEET No.
•	<u>ECM:</u> 109684	1.27mm	<b>PITCH SLIM-GRI</b>	D®	<b>1</b> of <b>9</b>
A	<u>DATE:</u> 2016/11/17	VERTICAL SMT RECEPTACLE			
DOCUMEN	T NUMBER:	CREATED / REVISED BY:	CHECKED BY:	APPR	OVED BY:
78120001 SCHEONG GMENARLY		K	HLIM		
TEMPLATE FILENAME: PRODUCT_SPEC[SIZE_A4](V.2).DOC					

# molex

### **PRODUCT SPECIFICATION**

#### 3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

The following documents form a part of this specification to the extended specified herewith. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence

**Reference Product Specifications** 

2009890001 1.27mm Pitch SLIM-GRID<sup>®</sup> Shrouded Header

879330001 1.27mm Pitch SLIM-GRID<sup>®</sup> Unshrouded Header

#### 4.0 RATINGS (DELETE WHERE APPLICABLE)

### 4.1 VOLTAGE

<u>125</u> Vac

#### 4.2 CURRENT

4.3 (Amp) per Pole

#### 4.3 TEMPERATURE

Operating:  $-55^{\circ}$ C to  $+105^{\circ}$ C Non-operating:  $-55^{\circ}$ C to  $+105^{\circ}$ C

#### 5.0 PERFORMANCE

#### 5.1 ELECTRICAL REQUIREMENTS

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
1	Contact Resistance (LLCR)	Mate connectors: apply a maximum voltage of <b>20</b> mV and a current of <b>100</b> mA. (EIA-364-23) Note: Wire resistance and traces shall be removed from the measured value.	<b>30</b> milliohms [MAXIMUM] [initial]
2	Insulation Resistance	Mated & unmount connectors: apply a voltage of <b>500</b> VDC between adjacent terminals and between terminals to ground. (EIA-364-21)	<b>1000</b> Megohms [MINIMUM]
3	Dielectric Withstanding Voltage	Mated & unmount connectors: apply a voltage of <b>1000</b> VAC for <b>1</b> minute between adjacent terminals and between terminals to ground. (EIA-364-20)	No breakdown; Current leakage < <b>5</b> mA

<b>REVISION:</b>	ECR/ECN INFORMATION:	TITLE: PRODU	TTLE: PRODUCT SPECIFICATION SHEE		SHEET No.
Α	<u>ECM:</u> 109684	1.27mm	PITCH SLIM-GRI	D®	<b>2</b> of <b>9</b>
A	<u>DATE:</u> 2016/11/17	VERTICA	L SMT RECEPTA	CLE	<b>2</b> of <b>9</b>
DOCUMEN	T NUMBER:	CREATED / REVISED BY:	CHECKED BY:	APPRO	OVED BY:
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			TEMPLATE FILENAM	E: PRODUCT_SPE	C[SIZE_A4](V.2).DOC

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4	Temperature Rise	Mate connectors: measure the temperature rise of the contact when the maximum DC rated current is passed.	Temperature rise: +30°C [MAXIMUM]	
		(EIA-364-70, Method 1)		

#### 5.2 MECHANICAL REQUIREMENTS

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ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
5	Connector Mate & Unmate Force	Mate and unmate connectors at a rate of <b>25.4 mm/min</b> (EIA-364-13D, Method A)	Mate Force 15N (24ckt) 10N (4ckt) [MAXIMUM] Unmate Force 3.0N (24ckt) 0.5N (4ckt)
			[MINIMUM] Appearance: No Damage
6	Durability	Mate connectors up to <b>50</b> cycles at a maximum rate of <b>500 ±50 cycles/hr</b> . (EIA-364-09)	Contact Resistance: <b>15</b> milliΩ [MAXIMUM] [CHANGE FROM INITIAL]
7	Reseating	Manually mate and unmate the connector with mating half for <b>3 cycles</b> with rate of <b>5</b> <b>cycles/min</b> maximum. (EIA-364-09)	Appearance: No Damage Contact Resistance: <b>15</b> milliΩ [MAXIMUM] [CHANGE FROM INITIAL]
8	Terminal Retention Force (in Housing)	Axial pullout force on the terminal in the housing at a rate of $25 \pm 6$ mm ( $1 \pm \frac{1}{4}$ inch) per minute. (EIA-364-29, Method C)	<b>2.22N</b> [MINIMUN]

REVISION:	ECR/ECN INFORMATION:		CT SPECIFICATIO	ON	SHEET No.
Α	<u>ECM:</u> 109684		PITCH SLIM-GRI	-	<b>3</b> of <b>9</b>
A	<u>DATE:</u> 2016/11/17	VERTICA	L SMT RECEPTA	CLE	3013
DOCUMEN	T NUMBER:	CREATED / REVISED BY:	CHECKED BY:	APPR	OVED BY:
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9	Vibration	Mate connectors and subject following vibration conditions of <b>2 hours</b> in each 3 mutuall perpendicular axis. Amplitude: <b>1.52mm</b> (.060 inter- peak Test pulse: <b>half sine</b> Sweep: <b>10-&gt;55-&gt;10 Hz</b> in <b>1</b> Duration: <b>2 hours</b> in each x- (EIA-364-28, Test Condition	s, for a period ly ch) peak to <b>minute</b> -y-z axis.	Appearance: No Damage <b>15</b> milliohms [MAXIMUM] (change from initial) Discontinuity: <b>1.0 μs</b> [maximum]
10	Mechanical shock	Mate connectors and subject to the following shock conditions, 3 shocks shall be applied along 3 mutually perpendicular axis. (total of 18 shocks) Peak value: <b>490</b> m/s sq. (50G) Test pulse : <b>half sine</b> Duration : <b>11 ms</b> in each x-y-z axis (EIA-364-27B Condition A)		Appearance: No Damage Contact Resistance: <b>15</b> milliΩ [MAXIMUM] [CHANGE FROM INITIAL] Discontinuity: <b>1.0 μs</b> [maximum]
11	Thermal shock	-55+0/-5   Transfer time from cold to hot   +105+3/-0   Transfer time from	Duration (minutes) 30 maximum 30 maximum	Appearance: No Damage Contact Resistance: <b>15</b> milliΩ [MAXIMUM] [CHANGE FROM INITIAL]
12	Temperature life	Mate connectors, expose to: Temperature: <b>105 ± 2</b> °c Duration: <b>96</b> hours. (EIA-364-17, Method A, Con		Appearance: No Damage Contact Resistance: <b>15</b> milliΩ [MAXIMUM] [CHANGE FROM INITIAL]

REVISION:	ECR/ECN INFORMATION:	TITLE: PRODU	TLE: PRODUCT SPECIFICATION SH		SHEET No.
۸	<u>ECM:</u> 109684	1.27mm	PITCH SLIM-GRI	D®	<b>4</b> of <b>9</b>
Α	<u>DATE:</u> 2016/11/17	VERTICA	L SMT RECEPTA	CLE	<b>4</b> 01 <b>3</b>
DOCUMEN	T NUMBER:	CREATED / REVISED BY:	CHECKED BY:	<u>APPR(</u>	OVED BY:
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			TEMPLATE FILENAM	E: PRODUCT_SPE	C[SIZE_A4](V.2).DOC

		Mate connector and expose to:-	Appearance: No Damage
13	Cyclic temperature and humidity	Temperature: $25 \pm 3 \degree C$ @ Humidity: $80\% \pm 3\%$ And Temperature: $65 \pm 3 \degree C$ @ Humidity: $50\% \pm 3\%$ Ramp times should be 0.5 hour and dwell times should be 1.0 hour. Dwell times start when the temperature and humidity have stabilized within the specified levels. Duration: 24 cycles (72 hours)	Contact Resistance: <b>15</b> milliΩ [MAXIMUM] [CHANGE FROM INITIAL] Dielectric withstanding Voltage: No breakdown Insulation resistance: <b>1000</b> megaΩ minimum
		Mate connectors and expose to:	Appearance: No Damage
14	Low temperature test	Temperature: <b>-40 ± 3</b> °C Duration: <b>96 +5/-0</b> hours (EIA-364-59A)	Contact Resistance: <b>15</b> milliΩ [MAXIMUM]
		(EIA-304-39A)	[CHANGE FROM INITIAL] Appearance: No Damage
15	SO₂ gas (gold plated only)	Mate connectors and expose to: SO <sub>2</sub> gas density: <b>50 ±5</b> ppm Temperature: <b>40 ±2</b> °C Duration: <b>24 hours</b>	Contact Resistance: <b>15</b> milliΩ [MAXIMUM] [CHANGE FROM INITIAL]
16	Salt spray	Expose the mated connectors to the following salt mist condition: Concentration : $5 \pm 1\%$ Temperature : $35 \pm 1/-2^{\circ}$ C Test time : $48$ hours (note: immediately after exposure, the test specimens shall be dipped in running tap ( $\leq 38^{\circ}$ C) for 5 mins max and dried for 16 hour max in a circulating air oven at 38 $\pm 3^{\circ}$ C. Sample examination done in room temperature. (EIA-364-26C, Condition B)	Appearance: No Damage Contact Resistance: <b>15</b> milliΩ [MAXIMUM] [CHANGE FROM INITIAL]

REVISION:	ECR/ECN INFORMATION: ECM: <b>109684</b> DATE: <b>2016/11/17</b>	1.27mm	CT SPECIFICATIO PITCH SLIM-GRI L SMT RECEPTA	D®	<u>SHEET No.</u> 5 of 9
DOCUMEN	T NUMBER:	CREATED / REVISED BY:	CHECKED BY:	APPRO	<u>OVED BY:</u>
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17	Solderability	Unmate connector. Steam age for <b>8 hour ± 15 min.</b> (precondition: Condition C) <u>SMT</u> Surface mount process simulation test Solder paste is deposited onto screen (e.g.ceramic plate) via stencil. The connectors are placed onto the solder paste print. Subject the substrate and component to the reflow process through a convection oven. Refer to section 8.0 for temperature profile. Flux type: ROL0	95% of the immersed area must show no voids, pin holes
18	Resistance to solder Heats	SMT Convection reflow Sample to be passed through reflow over according to temperature profiles (shown in section 8.0) (EIA-364-56C, Procedure 6)	Appearance: no damage

#### 6.0 PACKAGING

Parts shall be packaged to protect against damage during handling, transit and storage. Parts are packaged in bulk, tape and reel or tube, refer to Appropriate Sales Drawing and Packaging Specification for specific information.

#### 7.0 OTHERS

7.1 Although some discolouration could be seen on the soldertail after reflow, it does not impact on the product's performance.

7.2 Mating should be performed as close as possible to the mating axis for the delicate ckt sizes.

REVISION:	ECR/ECN INFORMATION:	TITLE: PRODU	CT SPECIFICATIO	ON	SHEET No.		
٨	<u>ECM:</u> 109684	1.27mm	<b>6</b> of <b>9</b>				
Α	<u>DATE:</u> 2016/11/17	VERTICA	0019				
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#### **8.0 TEST SEQUENCE**

36	equential Tests Group →	1	2	3	4	5	6	7	8	9.1	9.2	10	11
	Test or Examination $oldsymbol{\Psi}$												
	Sample size	5	5	5	5	5	5	5	5	5	5	5	5
	Resistance to Soldering Conditions	1	1	1	1	1	1	1	1		1		
Lo	w Level Contact Resistance (LLCR)	2, 5, 7	2, 5, 7, 9	2, 5, 7, 9		2, 4	2, 4	2, 4	3, 7				
	Insulation Resistance				2, 6								
Die	electric Withstanding Voltage				3, 7								
	Connector Mate								2, 6				
	Connector Unmate								4, 8				
	Durability	3(a)	3(a)	3(a)					5				
	Reseating	6	8										
	Vibration			6									
	Mechanical Shock			8									
	Thermal Shock		4		4								
	Temperature Life	4		4(a)									
Сус	clic Temperature & Humidity		6		5								
	Low Temperature Test					3							
	SO <sub>2</sub> gas (Gold plated)						3						
	Salt Spray							3					
F	Pin Retention (in housing)									1	2		
	Solderability											1	
	Temperature Rise												1
Note	es: (a) Preconditioning - Durability: 20cycle - Temperature life: (												
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